LAN3VSO

2.5G BASE-T LAN transformer, non-PoE



Photo is representative

Product features

- IEEE 802.3bz compliant
- 1500 Vac isolation between primary and secondary
- Single port, non-PoE
- Toroid core winding, open header, surface mount
- Weight 0.7 g typical
- Moisture sensitivity level (MSL): 1

Applications

- RJ45 network interface card
- · Ethernet switch, router
- · SELV/ELV equipment
- Smart TV
- · Data centers
- Industrial automation

Environmental compliance and general specifications

- Operating ambient temperature range: -40 °C to +85 °C
- Storage temperature (component): -40 °C to +125 °C









Product specifications (+25 °C)

Part number⁴	Port	Pins	Inductance ^{1,5} (µH)	Leakage induc- tance ^{1,5} (μΗ)	DCR ^{2,5} (Ω)	CWW ^{1,5} (pF)	Turns Ratio³	Insertion loss ^{3,5} (dB)	Return loss ^{3,5} (dB)	Cross talk ⁵ (dB) (between each channel)	CMRR ^{3,5} (dB)
LAN3VS0S24151C2*	Single	24	150 @ 0 mA DC Bias	0.5	1.2	35	1CT:1CT, ±2%	-2 @ 1-200 MHz	-16 @ 1-40 MHz -16+10*log(f/40) @40.1- 200 MHz	-35 @ 1-100 MHz -25 @ 100-200 MHz	-25 @ 30-200 MHz

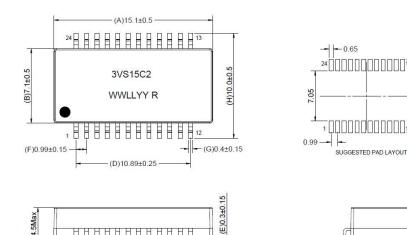
^{1.}Inductance (Transformer side), Leakage Inductance (Transformer side, short CMC side), CWW (Interwinding Capacitance, Pri to Sec): Test parameters: 100 KHz, 0.2V

2.DCR: CMC side

LAN3VSO = Product code

xxx: S24 = Single port, 24Pin xx: C2 = -40 to +85 °C

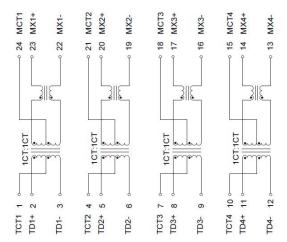
Mechanical parameters (mm) LAN3VSOS24151C2



0.10

(I)0.87±0.25

Schematic



Part marking: 3VS15C2, WWLLYY R = Lot code, Dot indicates pin 1

Pin length does not include include solder point

Silkscreen thickness: 0.1 mm to 0.15 mm

Traces or vias underneath the transformer is not recommended

^{3.} Turns ratio, Insertion loss, return loss and CMRR (Common mode rejection ratio): Primary to secondary: Polarity pin 1 side in phase

^{*}Operating temperature: -40 °C to +85 °C; Hipot: 1500 Vac, primary to secondary

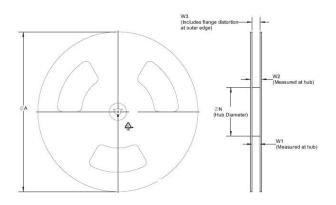
^{4.}Part number definition: LAN3VS0xxx151xx

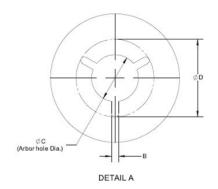
^{5.} DCR, CWW, Leakage inductance and Insertion loss values are maximum; Inductance, Return loss, CMRR and Cross talk values are minimum

Packaging information (mm)

Drawing not to scale

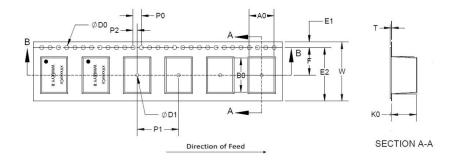
Supplied in tape and reel packaging on a 13" diameter reel, EIA-481 compliant





Reel dimension (mm)

Part number	ØA	В	ØC	ØD	ØN	W1	W2	W3
LAN3VSOS24151C2	330 ± 2	1.5 min	13 + 0.5 / -0.2	20.2 min	100	24.4 + 2 / -0	30.4 max	N/A



Tape dimension (mm)

Part number	Ao	Во	Ко	Т	w	F	E	E2	PO	P1	P2	ØD0	ØD1
LAN3VSOS24151C2	10.8 ± 0.15	15.7 ± 0.15	4.9 ± 0.1	0.4 ± 0.05	24 ± 0.3	11.5 ± 0.1	1.75 ± 0.1	21.85 min	4 ± 0.1	16 ± 0.1	2 ± 0.05	1.5 + 0.1 / -0	1.5 min

Packaging quantity

Part number	Reel	Bag	Вох	Carton
LAN3VS0S24151C2	850	850	1700	6800

General specifications

Solderability	J-STD-002.	8 hours steam age test, Solder: $+245$ °C \pm 5 °C (5 s)
Reflow	MIL-STD-202G Condition J	+260 °C ± 5 °C, 30 s ± 5 s, 1 times reflow
Resistance soldering heat	MIL-STD-202H, Method 210	+260 °C , 10 s
Operational life	MIL-STD-202, Method 108	1000 hours, +85 °C
Temperature cycling	MIL-STD-202G	High temperature= +125 °C, low temperature -40 °C, conversion time 15 minutes, 32 cycles
Biased humidity	MIL-STD-202G	+85 °C, 85% RH, Duration= 1000 hours
Vibration	MIL-STD-202	10 Hz to 80 Hz, Increased at +3 dB/octave, 80 Hz to 350 Hz, 0.053 g2/Hz, 350 Hz to 2000 Hz, Decrease at -3 dB/octave, X, Y and Z vibrate for 15 minutes each.
Mechanical shock	MIL-STD-202, Method 213	Half-sine shock pulse, peak=50 g's, 11 ms, total 18 shocks
Terminal strength	CBA203A-001	Standard: 4.5 kg, Minimum: 60 s, no visable damage

Solder reflow profile

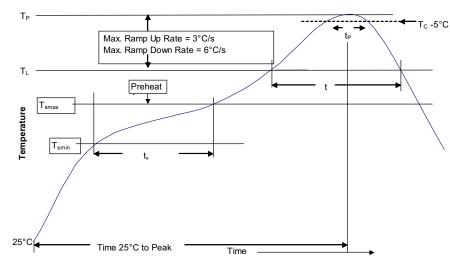


Table 1 - Standard SnPb solder (T_C)

Package thickness	Volume mm3 <350	Volume mm3 ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2 - Lead (Pb) free solder (T_C)

Package thickness	Volume mm³ <350	Volume mm³ 350 - 2000	Volume mm³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 – 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

Reference J-STD-020

Profile feature	Standard SnPb solder	Lead (Pb) free solder
Preheat and soak • Temperature min. (T _{smin})	100 °C	150 °C
• Temperature max. (T _{smax})	150 °C	200 °C
• Time (T _{smin} to T _{smax}) (t _s)	60-120 seconds	60-120 seconds
Ramp up rate T_L to T_p	3 °C/ second max.	3 °C/ second max.
Liquidous temperature (TL) Time (t_L) maintained above T_L	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak package body temperature (Tp)*	Table 1	Table 2
Time (t _p)* within 5 °C of the specified classification temperature (T _C)	20 seconds*	30 seconds*
Ramp-down rate (T _p to T _L)	6 °C/ second max.	6 °C/ second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

 $^{^{\}star}$ Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

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